INTESA 2019 Workshop

INTelligent Embedded Systems Architectures and Applications

Call for papers and participation



- → October 2019, Exact day TBD
- → Co-Located with ES WEEK 2019 Oct. 13 18, 2019, New York, USA
- → http://intesa-workshop.polimi.it

The INTESA workshop aims to give an up-to-date picture of intelligent embedded systems architectures and applications with emphasis on Smart IoT and Cyber Physical Systems, including hot topics such as accelerating deep learning. The workshop covers several aspects, from the hardware related ones to embedded software and application issues, being complementary to most of the topic addressed during the ESWEEK. From the market standpoint, scientific progress in this field are considered crucial to fuel a widespread diffusion of the potential benefits offered by the Industry 4.0 perspective. The goal of the event is to create cross-fertilization of ideas between application developers and platform providers with the participation of a mix between academic and industry people.

The workshop is organized in two sessions: 1) "Architectures and design methodologies to support embedded intelligence", 2) "Embedded Intelligence: best practices and software support" in an exciting full-immersion day.

Organizers

- General Chair: Maurizio Martina (POLITO Politecnico di Torino, IT)
- Program Chair: William Fornaciari (POLIMI Politecnico di Milano, IT)
- Program Co-Chair: Federico Reghenzani (POLIMI Politecnico di Milano, IT)
- Publicity and Publication Chair: Carlo Galuzzi (Maastricht University, NL)

Topics

A non-exhaustive list of suggested topics for paper submission are the following ones. However, other submissions in line with the workshop objectives are welcome:

- Special purpose hardware to support deep learning in embedded architectures
- Edge computing for smart embedded systems: hardware and software aspects
- Run-time resource management for smart IoT/Edge Computing systems
- HW/SW codesign of Cyber Physical Systems
- Programming models for IoT/Edge computing applications
- Applications and case studies of intelligent embedded systems
- Design methodologies and platforms for wearable computing
- In-memory computing for unsupervised learning

Submission instructions

- Full-papers are allowed up to six (6) double-column pages in ACM Standard conference format. <u>The submission is blind, thus the paper must not contain any direct or indirect information of the authors.</u>
- Poster abstracts up to (2) double-column pages in ACM Standard conference format.
- Submit your papers to: https://easychair.org/conferences/?conf=intesa2019

Accepted papers will be included in the conference proceedings published by ACM International Conference Proceedings Series (ICPS). The authors of the best papers will also be asked to submit an extended version of their contribute to a Journal special issue.

Important dates

Paper submission:
20 July, 2019 at 24:00 AOE

Acceptance notification: 1 September, 2019
Camera ready: 20 September, 2019

Scientific Committee

- William Fornaciari (POLIMI, IT)
- Maurizio Martina (POLITO, IT)
- Luigi Carro (UFRGS, BR)
- Federico Reghenzani (POLIMI, IT)
- Andrea Calimera (POLITO, IT)
- Guido Dartmann (AACHEN, DE)
- Nikil Dutt (UC, US)
- Smail Niar (UPHF, FR)
- Jari Nurmi (TUNI, FI)
- Lionel Torres (LIRMM, FR)
- Michael Huebner (B-TU, DE)
- Franco Fummi (UNIVR, IT)
- Marcello Coppola (STM, FR)
- Farshad Firouzi (Advaneo, DE)